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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO
09/682,957	11/02/2001	Andres Bryant	BUR920010071US1	3893
23123	7590 12/03/2002			
SCHMEISER OLSEN & WATTS			EXAMINER	
18 E UNIVERSITY DRIVE SUITE # 101			LEWIS, MONICA	
MESA, AZ 8	201		ART UNIT	PAPER NUMBER
			2822	
			DATE MAILED: 12/03/2002	

Please find below and/or attached an Office communication concerning this application or proceeding.

	Application No.	Applicant(s)					
Office Action Summer	09/682,957	BRYANT ET AL.					
Office Action Summary	Examiner	Art Unit					
T. MAH. W. A. D. T.	Monica Lewis	2822					
The MAILING DATE of this communication app Period for Reply	ears on the cover sheet wi	th the correspondence address					
A SHORTENED STATUTORY PERIOD FOR REPLY THE MAILING DATE OF THIS COMMUNICATION.  - Extensions of time may be available under the provisions of 37 CFR 1.13 after SIX (6) MONTHS from the mailing date of this communication.  - If the period for reply specified above is less than thirty (30) days, a reply If NO period for reply is specified above, the maximum statutory period w - Failure to reply within the set or extended period for reply will, by statute, - Any reply received by the Office later than three months after the mailing earned patent term adjustment. See 37 CFR 1.704(b).  Status	36(a). In no event, however, may a re within the statutory minimum of thirt rill apply and will expire SIX (6) MON cause the application to become AB	eply be timely filed y (30) days will be considered timely. THS from the mailing date of this communication. ANDONED (35 U.S.C. 8 133)					
1) Responsive to communication(s) filed on 02 N	lovember 2001 .						
2a) This action is <b>FINAL</b> . 2b) This	s action is non-final.						
3) Since this application is in condition for allowa closed in accordance with the practice under a Disposition of Claims	nce except for formal mat Ex parte Quayle, 1935 C.D	ters, prosecution as to the merits is 0. 11, 453 O.G. 213.					
4)⊠ Claim(s) <u>8-20</u> is/are pending in the application							
4a) Of the above claim(s) is/are withdrawn from consideration.							
5) Claim(s) is/are allowed.							
6)⊠ Claim(s) <u>8-20</u> is/are rejected.							
7) Claim(s) is/are objected to.							
8) Claim(s) are subject to restriction and/or	election requirement						
Application Papers							
9)☐ The specification is objected to by the Examiner							
10)⊠ The drawing(s) filed on <u>02 November 2001</u> is/ar	e: a)⊠ accepted or b)⊡ ob	jected to by the Examiner.					
Applicant may not request that any objection to the	drawing(s) be held in abeya	nce. See 37 CFR 1.85(a).					
11)☐ The proposed drawing correction filed on is: a)☐ approved b)☐ disapproved by the Examiner.							
If approved, corrected drawings are required in rep	ly to this Office action.						
12) The oath or declaration is objected to by the Exa	aminer.						
Priority under 35 U.S.C. §§ 119 and 120							
13) Acknowledgment is made of a claim for foreign	priority under 35 U.S.C. §	119(a)-(d) or (f).					
a) All b) Some * c) None of:							
1. Certified copies of the priority documents have been received.							
2. Certified copies of the priority documents have been received in Application No							
<ul> <li>3. Copies of the certified copies of the priori</li> <li>application from the International Bur</li> <li>* See the attached detailed Office action for a list of</li> </ul>	eau (PCT Rule 17.2(a)).	•					
14) Acknowledgment is made of a claim for domestic	priority under 35 U.S.C. §	§ 119(e) (to a provisional application).					
a) ☐ The translation of the foreign language prov 15)☐ Acknowledgment is made of a claim for domestic	• •						
Attachment(s)	•						
1) Notice of References Cited (PTO-892) 2) Notice of Draftsperson's Patent Drawing Review (PTO-948) 3) Information Disclosure Statement(s) (PTO-1449) Paper No(s) 2.	5) Notice of Ir	lummary (PTO-413) Paper No(s)  Iformal Patent Application (PTO-152)					

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### **DETAILED ACTION**

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1. This office action is in response to the election filed November 5, 2002.

#### Election/Restrictions

2. Applicant's election of Group I in Paper No. 4 is acknowledged. Because applicant did not distinctly and specifically point out the supposed errors in the restriction requirement, the election has been treated as an election without traverse (MPEP § 818.03(a)).

# **Priority**

3. It is noted that this application appears to claim subject matter disclosed in prior copending Application No. 09/886,823, filed 6/21/01. A reference to the prior application must be inserted as the first sentence of the specification of this application or in an application data sheet (37 CFR 1.76), if applicant intends to rely on the filing date of the prior application under 35 U.S.C. 119(e) or 120. See 37 CFR 1.78(a). Also, the current status of all nonprovisional parent applications referenced should be included.

If the application is a utility or plant application filed on or after November 29, 2000, any claim for priority must be made during the pendency of the application and within the later of four months from the actual filing date of the application or sixteen months from the filing date of the prior application. See 37 CFR 1.78(a)(2) and (a)(5). This time period is not extendable and a failure to submit the reference required by 35 U.S.C. 119(e) and/or 120, where applicable, within this time period is considered a waiver of any benefit of such prior application(s) under 35 U.S.C. 119(e), 120, 121 and 365(c). A priority claim filed after the required time period may be accepted if it is accompanied by a grantable petition to accept an unintentionally delayed claim for priority under 35 U.S.C. 119(e), 120, 121 and 365(c). The petition must be accompanied by

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(1) a surcharge under 37 CFR 1.17(t), and (2) a statement that the entire delay between the date the claim was due under 37 CFR 1.78(a)(2) or (a)(5) and the date the claim was filed was unintentional. The Commissioner may require additional information where there is a question whether the delay was unintentional. The petition should be directed to the Office of Petitions, Box DAC, Assistant Commissioner for Patents, Washington, DC 20231.

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# Claim Rejections - 35 USC § 112

- 4. The following is a quotation of the second paragraph of 35 U.S.C. 112:
  The specification shall conclude with one or more claims particularly pointing out and distinctly claiming the subject matter which the applicant regards as his invention.
- 5. Claims 14 and 20 are rejected under 35 U.S.C. 112, second paragraph, as being indefinite for failing to particularly point out and distinctly claim the subject matter which applicant regards as the invention. It is not clear what is meant by the following: a) "within and abut" (See Claim 14); and b) "fin structure" (See Claims 14 and 20).

### Claim Rejections - 35 USC § 103

- 6. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
  - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 7. Claims 8-20, as far as understood, are rejected under 35 U.S.C. 103(a) as being unpatentable over Wu et al. (U.S. Patent No. 5,994,747) in view of Houston (U.S. Patent No. 6,045,625).

In regards to claim 8, Wu et al. ("Wu") discloses the following:

a) a semiconductor wafer overlying a semiconductor layer (2) (See Figure 9);

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b) a first recess and a second recess formed through the semiconductor layer (See Figure 9);

- c) a body (6) formed from the semiconductor layer situated between the first recess and the second recess, the body comprising a top body surface and a bottom body surface that defines a body thickness (See Figure 9);
- d) a source structure (14) formed into the first recess, the source structure comprising a source region (See Figure 9);
- e) a drain region formed into the second recess, the drain structure comprising a drain region (See Figure 9); and
- f) a top portion of the source structure and a top portion of the drain structure are within and abut the body thickness.

In regards to claim 8, Wu fails to disclose the following:

a) a semiconductor layer overlying a buried insulator having at least two layers.

However, Houston discloses a semiconductor with an insulation layer that has various layers (See Figure 5e). It would have been obvious to one having ordinary skill in the art at the time the invention was made to modify the semiconductor device of Wu to include an insulation layer that has various layers as disclosed in Houston because it aids in eliminating warping.

In regards to claim 9, Wu discloses the following:

a) a semiconductor layer (See Figure 9).

In regards to claim 9, Wu fails to disclose the following:

a) the first layer of the buried insulator.

However, Houston discloses a semiconductor with an insulation layer (See Figure 5e). It would have been obvious to one having ordinary skill in the art at the time the invention was made to modify the semiconductor device of Wu to include an insulation layer as disclosed in Houston because it aids in eliminating warping.

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In regards to claim 10, Wu discloses the following:

a) a semiconductor layer comprises single crystal silicon (See Column 3 Line 43).

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In regards to claim 11, Wu fails to disclose the following:

a) the buried insulator comprises three layers, wherein a second layer is different

from the first layer and a third layer.

However, Houston discloses a semiconductor with an insulation layer that has various

layers (See Column 2 Lines 43-50). It would have been obvious to one having ordinary skill in

the art at the time the invention was made to modify the semiconductor device of Wu to include

an insulation layer that has various layers as disclosed in Houston because it aids in eliminating

warping.

In regards to claim 12, Wu fails to disclose the following:

a) the first layer comprises silicon dioxide, wherein the second layer comprises

silicon nitride, wherein the third layer comprises silicon dioxide.

However, Houston discloses a semiconductor with insulation layers that has silicon

dioxide and silicon nitride (See Column 2 Lines 43-50). It would have been obvious to one

having ordinary skill in the art at the time the invention was made to modify the semiconductor

device of Wu to include an insulation layer that has silicon dioxide and silicon nitride as

disclosed in Houston because it aids in providing low capacitance.

In regards to claim 13, Wu discloses the following:

a) a first recess and a second recess (See Figure 9).

In regards to claim 13, Wu fails to disclose the following:

a) a buried insulator.

However, Houston discloses a semiconductor with an insulation layer that has various layers (See Figure 5e). It would have been obvious to one having ordinary skill in the art at the time the invention was made to modify the semiconductor device of Wu to include an insulation layer that has various layers as disclosed in Houston because it aids in eliminating warping.

In regards to claim 14, Wu discloses the following:

a) the body comprises a fin structure that comprises a top fin structure surface a bottom fin structure surface that define a fin structure thickness, wherein the top portion of the source structure and the top portion of the drain structure are within and abut the fin structure thickness (See Figure 9).

In regards to claim 15, Wu discloses the following:

a) a silicon layer (See Figure 9).

In regards to claim 15, Wu fails to disclose the following:

a) a silicon layer overlying on a buried insulator that comprises a first buried insulator on a second buried insulator different from the first buried insulator layer, wherein the first buried insulator layer is at least as thick as the silicon.

However, Houston discloses a semiconductor with an insulation layer that has various layers (See Figure 5e and Column 2 Lines 43-50). It would have been obvious to one having ordinary skill in the art at the time the invention was made to modify the semiconductor device of Wu to include an insulation layer that has various layers as disclosed in Houston because it aids in eliminating warping.

In regards to claim 16, Wu fails to disclose the following:

a) the first buried insulator layer comprises silicon dioxide.

However, Houston discloses a semiconductor with an insulation layer that has silicon dioxide (See Column 2 Lines 43-50). It would have been obvious to one having ordinary skill in the art at the time the invention was made to modify the semiconductor device of Wu to include

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an insulation layer that has silicon dioxide as disclosed in Houston because it aids in providing low capacitance.

In regards to claim 17, Wu fails to disclose the following:

a) the second buried insulator layer comprises silicon nitride.

However, Houston discloses a semiconductor with an insulation layer that has silicon nitride (See Column 2 Lines 43-50). It would have been obvious to one having ordinary skill in the art at the time the invention was made to modify the semiconductor device of Wu to include an insulation layer that has silicon nitride as disclosed in Houston because it aids in providing low capacitance.

In regards to claim 18, Wu discloses the following:

a) a transistor (See Figure 9).

In regards to claim 19, Wu discloses the following:

a) the transistor comprises a source structure and a drain structure recessed through the first buried insulator layer (See Figure 9).

In regards to claim 20, Wu discloses the following:

a) the transistor further comprises a fin structure (See Figure 9).

#### Conclusion

8. The following prior art made of record and not relied upon is considered pertinent to applicant's disclosure: a) Brigham (U.S. Patent No. 6,274,913) a transistor structure with embedded source/drain junction; b) Yu (U.S. Patent No. 6,225,173) discloses a recessed channel structure; c) Brigham et al. (U.S. Publication No. 2001/0036693) discloses a shielded transistor; d) Tseng (U.S. Publication No. 2002/0168823) discloses a recessed lightly doped drain field

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effect transistor; e) Pfiester (U.S. Patent No. 5,426,315) discloses a thin film transistor; and f) Su

et al. (U.S. Patent No. 5,208,472) discloses a mos device.

9 Any inquiry concerning this communication or earlier communications from the

examiner should be directed to Monica Lewis whose telephone number is 703-305-3743.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Amir

Zarabian can be reached on 703-308-4905. The fax phone number for the organization where

this application or proceeding is assigned is 703-308-7722 for regular and after final

communications. Any inquiry of a general nature or relating to the status of this application or

proceeding should be directed to the receptionist whose telephone number is 703-308-0956.

ML

November 29, 2002

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